

January 2008

# FCAS20DN60BB

### Smart Power Module for SRM

#### **Features**

- 600V-20A 2-phase asymmetric bridge IGBT converter for SRM drive including control ICs for gate driving and protec-
- Single-grounded power supply due to built-in HVIC
- Isolation rating of 1500Vrms/min.
- Embedded bootstrap diode in the package

### **Applications**

2-phase SRM drives for home application vacuum cleaner.

# **General Description**

FCAS20DN60BB is an advanced smart power module for SRM drive that Fairchild has newly developed and designed to provide very compact and high performance SRM motor drives mainly targeting low-power SRM application especially for a vacuum air cleaner. It combines optimized circuit protection and drive matched to low-loss IGBTs. System reliability is further enhanced by the integrated under-voltage lock-out and shortcircuit protection. The high speed built-in HVIC provides optocoupler-less IGBT gate driving capability that further reduce the overall size of the system. In addition the incorporated HVIC facilitates the use of single-supply drive topology enabling the FCAS20DN60BB to be driven by only one drive supply voltage without negative bias.



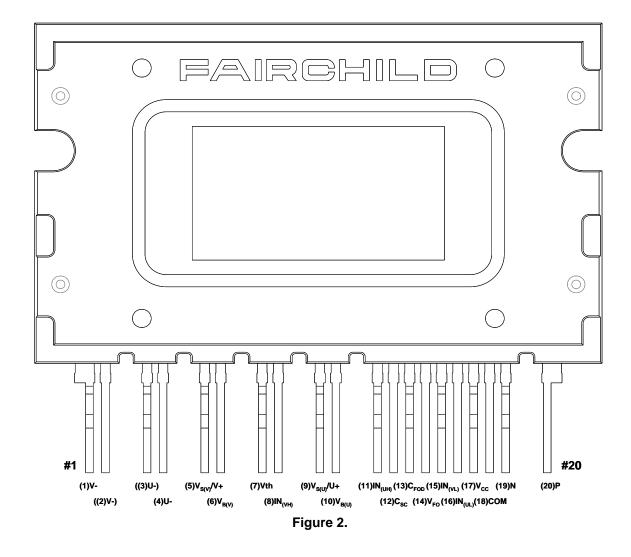
## **Integrated Power Functions**

• 600V-20A IGBT asymmetric converter for 2-phase SRM drives (Please refer to Figure 3)

# Integrated Drive, Protection and System Control Functions

- For high-side IGBTs: Gate drive circuit, High voltage isolated high-speed level shifting Control circuit under-voltage (UV) protection Note) Available bootstrap circuit example is given in Figures 11.
- For low-side IGBTs: Gate drive circuit, Short circuit protection (SC)
   Control supply circuit under-voltage (UV) protection
- Fault signaling: Corresponding to a UV fault (Low-side supply)
- Input interface: 5V CMOS/LSTTL compatible, Schmitt trigger input

## **Pin Configuration**



# **Pin Descriptions**

Pin Number	Pin Name	Pin Description
1	V-	Output for V- Leg
2	( V- )	Output for V- Leg
3	( U- )	Output for U- Leg
4	U-	Output for U- Leg
5	VS(V)/V+	Output for V+ Leg / High-side Bias Voltage Ground for V-phase IGBT Gate Driving
6	VB(V)	High-side Bias Voltage for V-phase IGBT Gate Driving
7	Vth	Thermistor Output
8	IN(VH)	Signal Input for V-phase High-side IGBT
9	VS(U)/U+	Output for U+ Leg / High-side Bias Voltage Ground for U-phase IGBT Gate Driving
10	VB(U)	High-side Bias Voltage for U-phase IGBT Gate Driving
11	IN(UH)	Signal Input for U-phase High-side IGBT
12	C <sub>SC</sub>	Capacitor (Low-pass Filter) for Short-Current Detection
13	C <sub>FOD</sub>	Capacitor for Fault Output Duration Time Selection
14	V <sub>FO</sub>	Fault Output
15	IN(VL)	Signal Input for V-phase Low-side IGBT
16	IN(UL)	Signal Input for U-phase Low-side IGBT
17	V <sub>CC</sub>	Common Bias Voltage for IC and IGBTs Driving
18	COM	Common Supply Ground
19	N	Negative DC-Link Input
20	Р	Positive DC-Link Input

# **Internal Equivalent Circuit and Input/Output Pins**

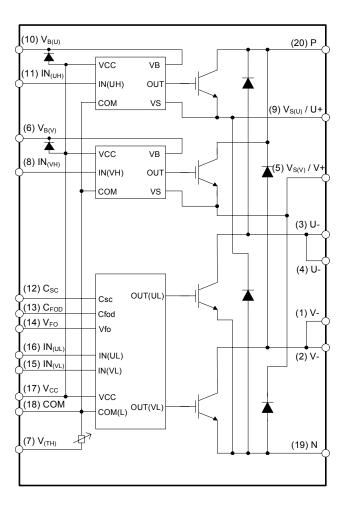


Figure 3.

# **Absolute Maximum Ratings** (T<sub>J</sub> = 25°C, Unless Otherwise Specified)

### **Inverter Part**

Symbol	Parameter	Conditions	Rating	Units
V <sub>PN(Surge)</sub>	Supply Voltage (Surge)	Applied between P- N	550	V
V <sub>CES</sub>	Collector-emitter Voltage		600	V
± I <sub>C</sub>	Each IGBT Collector Current	T <sub>C</sub> = 25°C	20	Α
± I <sub>CP</sub>	Each IGBT Collector Current (Peak)	T <sub>C</sub> = 25°C, Under 1ms Pulse Width	30	Α
P <sub>C</sub>	Collector Dissipation	T <sub>C</sub> = 25°C per One IGBT	22	W
T <sub>J</sub>	Operating Junction Temperature	(Note 1)	-20 ~ 125	°C

### **Control Part**

Symbol	Parameter Conditions		Rating	Units
V <sub>CC</sub>	Control Supply Voltage	Applied between V <sub>CC</sub> - COM	20	V
$V_{BS}$	High-side Control Bias Voltage	Applied between V <sub>B</sub> - V <sub>S</sub>	20	V
$V_{IN}$	Input Signal Voltage	Applied between IN <sub>(H)</sub> , IN <sub>(L)</sub> - COM	-0.3~17	V
$V_{FO}$	Fault Output Supply Voltage	Applied between V <sub>FO</sub> - COM	-0.3~V <sub>CC</sub> +0.3	V
I <sub>FO</sub>	Fault Output Current	Sink Current at V <sub>FO</sub> Pin	5	mA
V <sub>SC</sub>	Current Sensing Input Voltage	Applied between C <sub>SC</sub> - COM	-0.3~V <sub>CC</sub> +0.3	V

# **Total System**

Symbol	Parameter	Conditions	Rating	Units
V <sub>PN(PROT)</sub>	Self Protection Supply Voltage Limit (Short Circuit Protection Capability)	$V_{CC} = V_{BS} = 13.5 \sim 16.5 V$ $T_J = 125^{\circ}C$ , Non-repetitive, less than $2\mu s$	400	V
T <sub>STG</sub>	Storage Temperature		-40 ~ 125	°C
V <sub>ISO</sub>	Isolation Voltage	60Hz, Sinusoidal, AC 1 minute, Connection Pins to IMS	1500	V <sub>rms</sub>

## **Thermal Resistance**

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Units
R <sub>th(j-c)Q</sub>		Each IGBT under Operating Condition	-	-	4.0	°C/W
R <sub>th(j-c)F</sub>	Resistance	Each FWDi under Operating Condition	-	-	9.4	°C/W

#### Note:

# **Package Marking & Ordering Information**

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FCAS20DN60BB	FCAS20DN60BB	SPM20-BC	_	_	11

<sup>1.</sup> For the measurement point of case temperature ( $T_{\mbox{\scriptsize C}}$ ), please refer to Figure 2.

# **Electrical Characteristics** (T<sub>J</sub> = 25°C, Unless Otherwise Specified)

### **Inverter Part**

Sy	ymbol	Parameter	Cond	itions	Min.	Тур.	Max.	Units
V	CE(SAT)	Collector-Emitter Saturation Voltage	V <sub>CC</sub> = V <sub>BS</sub> = 15V		-	-	2.05	V
	V <sub>FM</sub>	FWDi Forward Voltage	V <sub>IN</sub> = 0V	I <sub>C</sub> = 15A, T <sub>J</sub> = 25°C	-	-	2.8	V
HS	t <sub>ON</sub>	Switching Times	$V_{PN} = 300V, V_{CC} = V_{B}$	S = 15V	-	680	-	ns
	t <sub>C(ON)</sub>		$I_C = 20A$	ive I oad	-	500	-	ns
	t <sub>OFF</sub>		V <sub>IN</sub> = 0V ↔ 5V, Inductive Load (Note 2)		-	1130	-	ns
	t <sub>C(OFF)</sub>				-	160	-	ns
	t <sub>rr</sub>				-	85	-	ns
LS	t <sub>ON</sub>		$V_{PN} = 300V, V_{CC} = V_{B}$	<sub>S</sub> = 15V	-	1000	-	ns
	t <sub>C(ON)</sub>		$I_C = 20A$ $V_{IN} = 0V \leftrightarrow 5V$ , Induct	ive I oad	-	1100	-	ns
	t <sub>OFF</sub>		(Note 2)	ive Load	-	1050	-	ns
	t <sub>C(OFF)</sub>				-	180	-	ns
	t <sub>rr</sub>				-	80	-	ns
	I <sub>CES</sub>	Collector - Emitter Leakage Current	V <sub>CE</sub> = V <sub>CES</sub>		-	-	250	μА

#### Note

<sup>2.</sup> t<sub>ON</sub> and t<sub>OFF</sub> include the propagation delay time of the internal drive IC. t<sub>C(ON)</sub> and t<sub>C(OFF)</sub> are the switching time of IGBT itself under the given gate driving condition internally. For the detailed information, please see Figure 4.

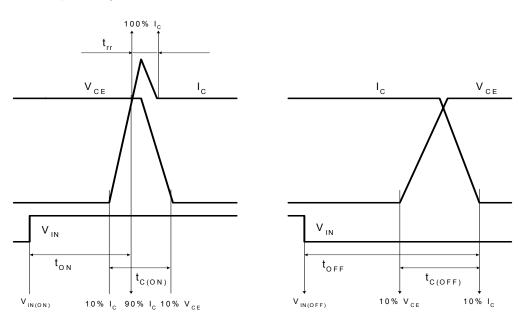


Figure 4. Switching Time Definition

# $\textbf{Electrical Characteristics} \ \, (T_J = 25^{\circ}C, \, \text{Unless Otherwise Specified})$

### **Control Part**

Symbol	Parameter	Cor	nditions	Min.	Тур.	Max.	Units
I <sub>QCC</sub>	Quiescent V <sub>CC</sub> Supply Current	V <sub>CC</sub> = 15V IN <sub>(L)</sub> = 0V	V <sub>CC</sub> - COM	-	-	24	mA
I <sub>QBS</sub>	Quiescent V <sub>BS</sub> Supply Current	V <sub>BS</sub> = 15V IN <sub>(H)</sub> = 0V	V <sub>B</sub> - V <sub>S</sub>	-	-	500	μА
V <sub>FOH</sub>	Fault Output Voltage	V <sub>SC</sub> = 0V, V <sub>FO</sub> Circuit:	4.7kΩ to 5V Pull-up	4.5	-	-	V
V <sub>FOL</sub>		$V_{SC}$ = 1V, $V_{FO}$ Circuit: 4.7k $\Omega$ to 5V Pull-up		-	-	0.8	V
V <sub>SC(ref)</sub>	Short Circuit Trip Level	V <sub>CC</sub> = 15V (Note 3)		0.45	0.5	0.55	V
UV <sub>CCD</sub>	Supply Circuit Under-	Detection Level	Applied between	10.7	11.9	13.0	V
UV <sub>CCR</sub>	Voltage Protection	Reset Level	V <sub>CC</sub> - COM	11.2	12.4	13.2	V
UV <sub>BSD</sub>		Detection Level	Applied between	10.1	11.3	12.5	V
UV <sub>BSR</sub>		Reset Level	V <sub>B</sub> - V <sub>S</sub>	10.5	11.7	12.9	V
t <sub>FOD</sub>	Fault-out Pulse Width	C <sub>FOD</sub> = 33nF (Note 4)		1.0	1.8	-	ms
V <sub>IH</sub>	ON Threshold Voltage	Logic'1' input voltage	Applied between	3.0	-	-	V
V <sub>IL</sub>	OFF Threshold Voltage	Logic'0' input voltage	IN <sub>(H)</sub> , IN <sub>(L)</sub> - COM	-	-	0.8	V
R <sub>TH</sub>	Resistance of Thermistor	@ T <sub>C</sub> = 25°C (Note Fig. 9)		-	50	-	kΩ
		@ T <sub>C</sub> = 80°C (Note Fi	g. 9)	-	6.021	-	kΩ

#### Note

# **Recommended Operating Conditions**

Symbol	Parameter	Canditions	Value			Units
		Conditions	Min.	Тур.	Max.	Units
V <sub>PN</sub>	Supply Voltage	Applied between P - N	-	300	450	V
V <sub>CC</sub>	Control Supply Voltage	Applied between V <sub>CC</sub> - COM	13.5	15	16.5	V
V <sub>BS</sub>	High-side Bias Voltage	Applied between V <sub>B</sub> - V <sub>S</sub>	13.5	15	18.5	V
f <sub>PWM</sub>	PWM Input Signal	$T_{C} \le 100^{\circ}C, T_{J} \le 125^{\circ}C$	-	3	-	kHz
V <sub>IN(ON)</sub>	Input ON Voltage	Applied between IN <sub>(H)</sub> , IN <sub>(L)</sub> - COM		4 ~ 5.5		V
V <sub>IN(OFF)</sub>	Input OFF Voltage	Applied between IN <sub>(H)</sub> , IN <sub>(L)</sub> - COM		0 ~ 0.65		V

# **Bootstrap Diode Part**

Symbol	Parameter	Conditions	Rating	Units
$V_{RRM}$	Maixmum Repetitive Reveres Voltage		600	V
I <sub>F</sub>	Forward Current	T <sub>C</sub> = 25°C	0.5	Α
I <sub>FP</sub>	Forward Current (Peak)	T <sub>C</sub> = 25°C, Under 1ms Pulse Width	2	Α
TJ	Reverse Recovery Time		-20~125	°C

 $<sup>{\</sup>it 3. Short-circuit\ current\ protection\ is\ functioning\ only\ at\ the\ low-sides.}$ 

<sup>4.</sup> The fault-out pulse width  $t_{FOD}$  depends on the capacitance value of  $C_{FOD}$  according to the following approximate equation :  $C_{FOD} = 18.3 \times 10^{-6} \times t_{FOD}[F]$ 

# **Mechanical Characteristics and Ratings**

Parameter	Conditions		Units		
	Conditions	Min.	Тур.	Max.	Ullits
Mounting Torque	Mounting Screw - M3	5.17	6.29	7.30	Kg•cm
		0.51	0.62	0.72	N•m
Surface Flatness	Note Figure 5.	-	-	-	um
Weight		-	14.5	-	g

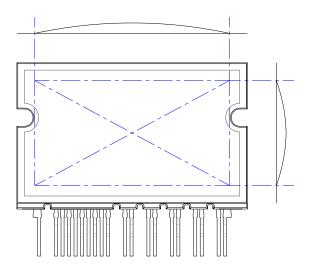
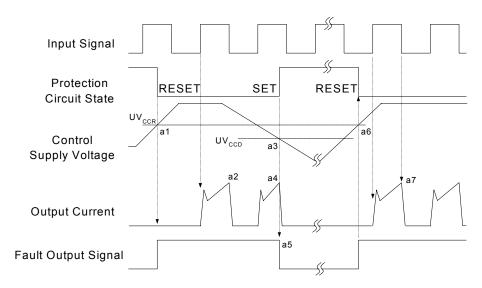


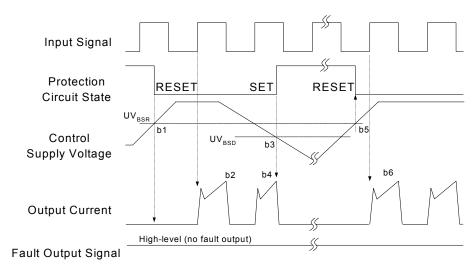
Figure 5. Flatness Measurement Position

### **Time Charts of Protective Function**



- a1 : Control supply voltage rises: After the voltage rises  $UV_{CCR}$ , the circuits start to operate when next input is applied.
- a2: Normal operation: IGBT ON and carrying current.
- a3 : Under voltage detection (UV<sub>CCD</sub>).
- a4: IGBT OFF in spite of control input condition.
- a5 : Fault output operation starts.
- a6 : Under voltage reset ( $UV_{CCR}$ ).
- a7: Normal operation: IGBT ON and carrying current.

Fig. 6. Under-Voltage Protection (Low-side)

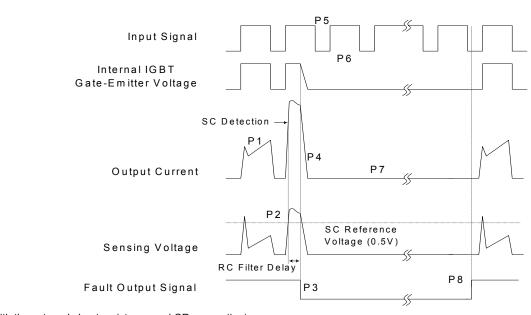


- $\verb|b1|: Control supply voltage rises: After the voltage reaches UV_{BSR}, the circuits start to operate when next input is applied.$
- b2: Normal operation: IGBT ON and carrying current.
- b3 : Under voltage detection (UV<sub>BSD</sub>).
- b4 : IGBT OFF in spite of control input condition, but there is no fault output signal.
- b5 : Under voltage reset (UV $_{\rm BSR}$ )

FCAS20DN60BB Rev. A

b6: Normal operation: IGBT ON and carrying current

Fig. 7. Under-Voltage Protection (High-side)



(with the external shunt resistance and CR connection)

c1: Normal operation: IGBT ON and carrying current.

c2 : Short circuit current detection (SC trigger).

c3: Hard IGBT gate interrupt.

c4: IGBT turns OFF.

c5 : Fault output timer operation starts: The pulse width of the fault output signal is set by the external capacitor  $C_{FO}$ .

c6 : Input "L" : IGBT OFF state.

c7 : Input "H": IGBT ON state, but during the active period of fault output the IGBT doesn't turn ON.

c8: IGBT OFF state

Fig. 8. Short-Circuit Current Protection (Low-side Operation only)

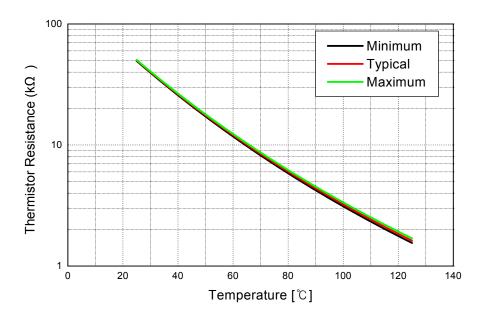
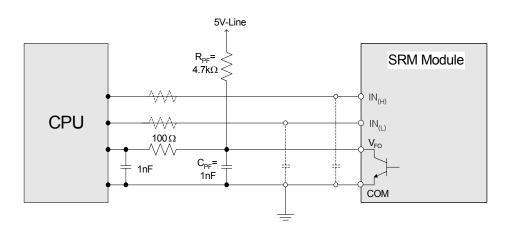


Fig. 9. R-T Curve of the Built-in Thermistor



#### Note:

- 5. RC coupling at each input (parts shown dotted) might change depending on the PWM control scheme used in the application and the wiring impedance of the application's printed circuit board. The input signal section integrates 3.3kΩ(typ.) pull-down resistor. Therefore, when using an external filtering resistor, please pay attention to the signal voltage drop at input terminal.
- 6. The logic input is compatible with standard CMOS or LSTTL outputs.

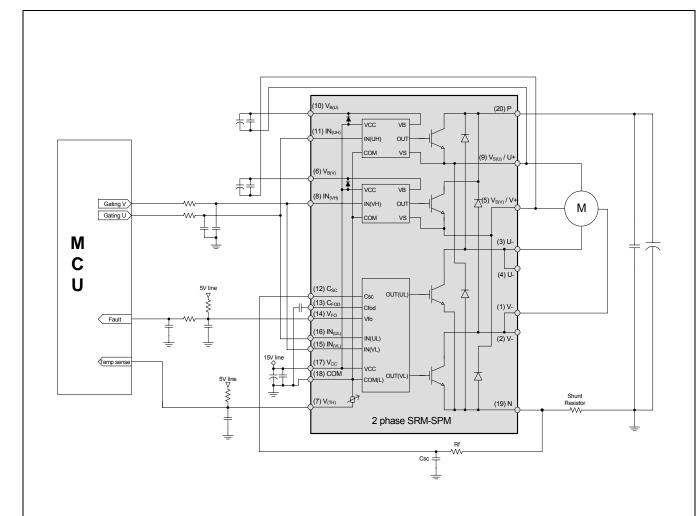
Figure 10. Recommended CPU I/O Interface Circuit

This Value depend on PWM Control Algorithm SRM module VΒ Vcc 15V-Line 0.1uE\_ IN НО 18uF COM VS Output Vcc 1000uF 💳 =1uF IN OUT  ${\rm COM}\ {\rm V_{SL}}$ 

### Note:

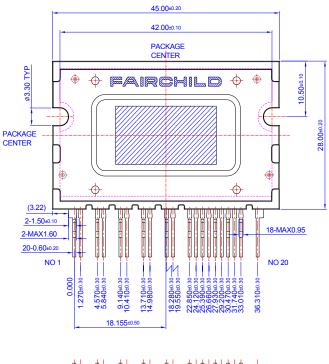
1) The ceramic capacitor placed between V<sub>CC</sub>-COM should be over 1uF and mounted as close to the pins of the SPM as possible.

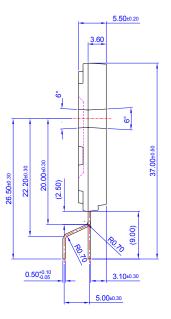
Figure 11. Recommended Bootstrap Operation Circuit and Parameters



**Figure 12. Typical Application Circuit** 

# **Detailed Package Outline Drawings**











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